

DescriptionBackground of the Invention5 Field of the invention

The present invention relates to a novel process for preparing compound oxide type superconductors, more particularly, a novel process for preparing superconductors of bismuth-containing compound oxides such as Bi-Sr-Ca-Cu system.

Description of the related art

15 The superconductivity is a phenomenon which is explained to be a kind of phase change of electrons under which the electric resistance becomes zero and the perfect diamagnetism is observed. Under the superconductivity, permanent currents of high density flow without any loss. Therefore, when the technology of superconductivity can be applied to electric power transmission power loss of about 7 % which occurs in the electric power transmission today can be saved greatly. Development of superconductor is also expected in the field of measurement and of medical treatment such as NMR, π neutrons medical treatment or high-energy physical experiments. In the applications of electromagnets for generating strong magnetic fields, the technology of superconductivity is expected to accelerate development of the technology of fusion power generation, MHD power generation, magnetic levitation trains and magnetically propelled ships.

Several superconducting devices have been proposed and developed in electronics. A typical application of the superconductors is Josephson device in which quantum efficiency is observed macroscopically when an electric current is passed through a weak junction arranged between two superconductors. The tunnel junction type Josephson device is expected to be a high-speed and low-power consuming switching device owing to a smaller energy gap of the superconducting material. Development of the superconducting devices such as high-speed logic units or of no power-loss wiring materials is also demanded in the field of high-speed computers in which the power consumption per unit area is reaching the upper limit of the cooling capacity with increment of the integration density in order to reduce energy consumption.

The critical temperature "T_c" of superconductivity, however, could not exceed 23.2 K of Nb₃Ge which was the the highest T_c for the past ten years. The possibility of existence of new types of superconducting materials having much higher T_c was revealed by Bednorz and Müller, who discovered a new oxide type superconductor in 1986 (Z. Phys. B64, 1986 p189).

35 It has been known that certain ceramic materials of compound oxides exhibit the property of superconductivity. For example, U. S. patent No. 3,932,315 discloses Ba-Pb-Bi type compound oxides which show superconductivity and Japanese patent laid-open No. 60-173,885 discloses that Ba-Bi type compound oxides also show superconductivity. These superconductors, however, possess rather lower transition temperatures of about 10 K and hence usage of liquidized helium (boiling point of 4.2 K) as cryogen is indispensable to realize superconductivity.

The new type compound oxide superconductor discovered by Bednorz and Müller is represented by [La, Sr]₂CuO₄ which is called the K₂NiF₄-type oxide having a crystal structure which is similar to known perovskite type oxides. The K₂NiF₄-type compound oxides show such higher T_c as 30 K which are much higher than those of known superconducting materials. It was also reported that C. W. Chu et al. 45 discovered, in the United States of America, another superconducting material so called YBCO type represented by YBa₂Cu₃O_{7-x} having the critical temperature of about 90 K in February 1987 (Physical Review letters, Vol. 58, No. 9, p908).

Maeda et al reported another type new superconducting material of Bi-Sr-Ca-Cu-O system (Japanese Journal of Applied Physics. Vol. 27, No. 2, p 1209 to 1210).

50 Bismuth type compound oxides are chemically much stabler than the abovementioned YBCO type compound oxide and have such a very important merit that high T_c superconductors of higher than 100 K can be realized without using rare earth elements as a constituent element so that the production cost can be reduced.

The above-mentioned new types of superconducting materials can be obtained by solid reaction in a bulk form of sintered block which was obtained by sintering a powder mixture of oxides or carbonates of constituent metal elements which has predetermined atomic ratios.

They can also be deposited on a substrate in a form of a thin film by physical vapour deposition (PVD) technique such as RF sputtering, vacuum deposition, ion-plating or MBE or chemical vapor deposition

(CVD) technique such as thermal CVD, plasma CVD, photo-CVD or MOCVD.

In the case of production of bismuth type oxide superconductors, however, there is a special problem, because, the vapour pressure of bismuth (Bi) is very different from those of the other constituent elements, so that it is very difficult to control the composition of the product. Still more, the products obtained by the conventional process are porous sintered articles having relatively lower density and being not homogeneous in quality. Therefore, it is requested to improve the quality of bismuth type compound oxides.

An object of the present invention is to overcome the problem of the conventional process and to provide a novel process for preparing high Tc bismuth type superconductors such as Bi-Sr-Ca-Cu system of high quality easily.

Summary of the Invention

The present invention provides a process for preparing superconductor of bismuth-containing compound oxide, characterized by the steps of preparing "an intermediate compound oxide" containing metal elements except bismuth which are constituent elements of the product superconductor and then subjecting the intermediate compound oxide to heat-treatment at a temperature between 750 and 950°C in a atmosphere of bismuth oxide vapour, so that bismuth oxide is reacted with the intermediate compound oxide to produce the product superconductor.

The bismuth oxide vapour is preferably created by beating bismuth oxide powder in a chamber.

The product superconductor according to the present invention is preferably in a form of thin film deposited on a substrate and also can be a block or a pre-shaped article such as a coil or a ring.

The process according to the present invention is applicable to any bismuth-containing compound superconductor including the following typical system represented by the general formula:



in which "m", "n", "x" and "y" are numbers each satisfying respective ranges of $6 \leq m \leq 16$, $4 \leq n \leq 12$, $0.2 < x < 0.8$ and $-2 \leq y \leq +2$ and $p = 6 + m + n$.

The compound oxides of this system consist mainly of the following formula: $\text{Bi}_4\text{Sr}_4\text{Ca}_4\text{Cu}_6\text{O}_{20+y}$

As the other type bismuth-containing compound oxides to which the present invention is applicable, it can be mentioned the following systems:

Bi-Pb-Sb-Sr-Ca-Cu-O system (132 K),

(Bi, Ti, Pb)-Sr-Ca-Cu-O system (110 K),

Bi-Pb-Sr-Ca-Cu-O system (107 K),

Bi-Y-Ba-Cu-O system (100 K),

Bi-(Sr, Ln)-Cu-O system (32 to 42 K),

(note) Ln : lanthanide element

Brief Description of the drawings

FIG. 1 is an illustrative view of an apparatus which can be used for carrying out the process according to the present invention.

Description of the Preferred Embodiments

As described above, in the case of bismuth type compound oxides, it is very difficult to control effectively the composition of the product, because bismuth (Bi) has vapour pressure very different from the other constituent metal elements.

The essence of the present invention resides in that the final product of compound oxide is not produced directly as is the case of the conventional process but is produced by two steps. Namely, in the process according to the present invention, an intermediate compound oxide or a parent body is prepared firstly from the other constituent metal elements except bismuth which have a different vapour pressure comparing to the other constituent metal elements at the first stage and then bismuth oxide is added to the resulting intermediate compound oxide or parent body obtained.

The intermediate compound oxide or parent body can be in a form of a block or a shaped article but is preferably in a form of a thin film since the superconductor prepared by the process according to the present invention is obtained in the neighborhood of a surface of the intermediate compound or parent body.

The first stage for preparing the intermediate compound oxide of the other metal elements except bismuth and oxygen can be effected by the conventional solid reaction, physical vapour deposition or chemical vapour deposition.

The block or shaped article of the intermediate compound oxide or parent body can be prepared by solid reaction or sintering technique. In this case, a sintered mass of the intermediate compound oxide containing the other metal elements except bismuth is prepared by the steps of mixing powders of oxides, carbonates, nitrates or fluorides each containing at least one of the other constituent metal elements of the intermediate compound oxide in such a manner that a powder mixture contains the constituent metal elements in predetermined atomic ratios and then sintering the powder mixture. It is preferable to repeat the sintering operation and pulverization for more than one time. This solid reaction can be effected without difficulty because the vapour pressures of the other metal elements except bismuth are not so much different from each other.

As stated above, the intermediate compound oxide or parent body is preferably in a form of a thin film. Namely, the superconductor prepared by the process according to the present invention is obtained in the neighborhood of a surfaced of the intermediate compound or parent body because bismuth reacts mainly with the surface of the intermediate compound.

When a thin film is used as the intermediate compound or parent body, such thin film can be prepared by physical vapour deposition (PVD) technique such as RF magnetron sputtering, vacuum deposition, ion-plating, MBE or by chemical vapor deposition (CVD) technique such as thermal CVD, plasma CVD, photo CVD, MOCVD or the like. When RF magnetron sputtering, vacuum deposition or ion-plating method is used as the physical vapour deposition technique, the atomic ratios of metal elements contained in a vapour source or a target is adjusted according to difference in the evaporation rate as well as difference in adsorption of metal elements to the substrate. The vapour source is preferably a sintered mass which is prepared by powder-sintering technique of a material power mixture comprising metal elements and/or their oxides or carbonates or a sintered powder which is obtained by pulverizing the sintered mass. The vapour source can be also divided into a plurality of segments. In the case of the molecular beam epitaxy (MBE), elemental metals Bi, Sr, Ca and Cu or their compounds such as their oxides are evaporated by means of a K-cell or an ion beam gun. In this case, oxygen is supplied, if necessary, separately or additionally into an evaporation atmosphere.

The substrate on which the intermediate compound oxide is deposited is preferably a single crystal of MgO, ZrO₂, SrTiO₃, LiNbO₃, LiTaO₃, LaAlO₃, LaGaO₃ or the like. There may be used LiAlO₃, LiCaO₃, KTaO₃, CaF₂, BeF₂, CSZ calcium stabilized zirconia, YSZ yttrium stabilized zirconia or silicon. When a single crystal of silicon is used as the substrate, a buffer layer of MgO or ZrO₂ is preferably interposed between the intermediate compound oxide layer and the substrate.

The final superconductors obtained by the process according to the present invention show crystalline anisotropy in electric resistance, so that the current passing along a direction which is parallel to a plane defined by a-axis and b-axis of the crystal shows a very high critical current density, while the current passing along c-axis is relatively low. Therefore, it is preferable to give a desired orientation of crystal to the thin film. For example, when the thin film of the intermediate compound oxide is deposited on {001} plane of a single crystal of MgO or SrTiO₃, the c-axis of the crystal of the thin film deposited is oriented perpendicular or nearly perpendicular to a surface of the thin film, so that the critical current density (J_c) along the surface is improved. In special applications, it is possible to use {110} plane of the substrate, of SrTiO₃ in order to orient the c-axis of the crystal of the thin film deposited in order to orient the c-axis of the crystal of the thin film deposited in parallel to the surface so that higher current density is obtained to the direction of depth. Substrate made of a single crystal of MgO or SrTiO₃ are preferable because their thermal expansion coefficient is similar to that of the intermediate compound oxide and hence the thin film of the intermediate compound oxide does not receive serious thermal shock or stress by heat history caused by heat and cool of the substrate.

In a preferred embodiment, a thin film of an intermediate compound oxide of Sr-Ca-Cu-O system is deposited firstly on a substrate made of a single crystal of MgO by sputtering technique. A target used in the sputtering is a sintered block of Sr-Cs-Cu-O system compound oxide or sintered powder obtained by pulverizing the sintered block. In this case, the substrate is heated at a temperature between room temperature and 800 °C. Then the resulting thin film is exposed to or contacted with a mixture of bismuth vapour and oxygen gas or bismuth oxide vapour at a temperature between 750 and 950 °C so that bismuth/oxygen or bismuth oxide react with the intermediate compound oxide.

The contact of the intermediate compound oxide with the mixture of bismuth vapour and oxygen gas or bismuth oxide vapour can be effected in a closed chamber in which bismuth oxide vapour is created by heating a vapour source such as bismuth oxide powder. In a variation, a mixture of bismuth vapour and

oxygen gas or bismuth oxide vapour produced outside the chamber can be introduced into the chamber.

In the second stage, the intermediate compound oxide is preferably heated at a temperature between 750 and 950 °C. If the temperature is not higher than 750 °C, the intermediate compound oxide is not activated so that the reaction with bismuth does not proceed satisfactorily. To the contrary, if the temperature is not lower than 950 °C, the trapped bismuth atoms escape from the intermediate compound oxide so that the objective bismuth containing compound oxide is not obtained.

It is preferable to heat the vapour source at higher temperature than the intermediate compound oxide. If necessary, a suitable flux can be used in order to increase vapour pressure of the vapour source such as bismuth compound. This heat-treatment is continued preferably for a time duration between 5 minutes and 5 hours.

It is also preferable to increase the partial pressure of oxygen in the chamber in order to control the oxygen contents in the final product. The partial pressure of oxygen depends on the nature of the compound oxides to be produced and is selected usually at about 101 325 Pa (1atm).

The process according to the present invention is applicable to production of elongated articles such as wire, because the addition of bismuth can be effected in a relatively short time. Namely, a superconducting wire can be prepared by exposing a core made of the intermediate compound oxide to bismuth oxide vapour according to the present invention.

Now, an apparatus for carrying out the present invention will be described with reference to the attached drawings.

FIG. 1 is an illustrative view of an apparatus which can be used for carrying out the process according to the present invention. The apparatus is a closed furnace 1 which is provided with an inlet port 7 having a valve 9, an outlet port 8 having a valve 10, a substrate holder 4, a boat 5 for receiving bismuth-containing compound 11 thereon and a heater 6 for heating the boat 5. The furnace 1 is surrounded by an outer heater 2 which heats the furnace from outside. The boat 5 is faced to the substrate holder 4 so that bismuth vapour produced from the boat 5 is directed directly to a substrate 3 supported on the holder 4. The furnace 1 has a relief valve (not shown).

In operation, the substrate 3 having a thin film of intermediate compound oxide thereon is secured on the substrate holder 4. A block of intermediate compound oxide can be used in place of the substrate 3. Powder of bismuth-containing compound such as bismuth oxide is placed on the boat 5. Firstly, the furnace 1 is evacuated through the outlet port 8. After the valve 10 is closed, oxygen gas is introduced into the furnace 1 and then the valve 9 is closed. Then, the heater 6 is energized to evaporate the bismuth-containing compound for example at 1,040 °C and simultaneously the outer heater 2 is also energized to heat the substrate 3 having the intermediate compound oxide at 880 °C.

According to the present invention, following advantages are obtained:

- (1) The proportion of bismuth in the superconductor can be controlled precisely.
- (2) Homogeneous superconductors can be obtained.
- (3) The operation for adding bismuth can be carried out easily in relatively short time. Therefore, the process according to the present invention is applicable to production of elongated articles such as wire.

Now, the present invention will be described with reference to examples, but the scope of the invention should not be limited to them.

Example 1

Preparation of the intermediate compound oxide

The parent body or intermediate compound oxide was produced in a form of a thin film which was prepared by magnetron RF sputtering method.

A target used in the RF-magnetron sputtering was prepared by mixing intimately powders of oxides of Sr, Ca and Cu in such proportions that the atomic ratios of respective elements of Sr : Ca : Cu became 2 : 2 : 3 and then sintering the powder mixture at 900 °C for 12 hours. The resulting sintered mass of Sr-Ca-Cu compound oxide was pulverized to a sintered powder which was used as a powder target. A thin film of Sr-Ca-Cu compound oxide was deposited on {110} plane of MgO substrate under the following condition:

Substrate temperature	760 °C
Sputtering gas pressure	1.33 - 13.3 Pa (0.01 to 0.1 Torr)
Sputtering gas	Ar/O ₂ = 1 : 1
RF-frequency power	100 W
Thickness of the film	0.2 µm

Preparation of the superconductor

The resulting thin film as the intermediate compound oxide was subjected to heat-treatment with bismuth oxide vapour according to the present invention as follows :

The MgO substrate 3 having the thin film of Sr-Ca-Cu compound oxide was secured to the holder 4 as is shown in FIG. 1. The boat 5 which was faced to the substrate 3 was filled with bismuth oxide powder.

The furnace 1 was evacuated through the outlet port 8. After the valve 10 was closed, oxygen gas was introduced into the furnace 1 and then the valve 9 was closed so that the interior of the furnace is filled with oxygen gas. Then, the heater 2 was energized to heat the interior of the furnace to 880 °C, while the heater 6 was energized to heat the boat 5 up to 1,040 °C. When the boat 5 was heated at 1,040 °C, this temperature was maintained for one hour and then the heaters were de-energized.

After the furnace was cooled down to room temperature, the MgO substrate was taken out of the furnace to measure the critical temperature. Namely, the MgO substrate was dipped in liquid helium in a cryostat at 8 K in order to confirm that the thin film deposited on the substrate was changed to a superconductor, the temperature was elevated gradually to determine a critical temperature (T_c) where the thin film showed ordinal resistance.

It was confirmed that the critical temperature (T_c) of the thin film obtained was 97 K.

Example 2

Example 1 was repeated but, in this Example, the intermediate compound oxide was exposed to bismuth oxide vapour directly.

Namely, the sintered block of the intermediate compound oxide which was prepared by the same method as is described in "preparation of the intermediate compound oxide" of Example 1 was supported by the holder 4 and was heat-treated with bismuth oxide vapour.

The resulting heat-treated block showed a T_c of 105 K.

Example 3

Example 1 was repeated except that the intermediate compound oxide of Sr-Ca-Cu was replaced by an intermediate compound oxide of Pb-Sr-Ca-Cu. In this Example, Pb was added in a form of lead oxide and the atomic ratios in the material powder were adjusted to Pb : Sr : Ca : Cu = 0.3 : 2 : 2 : 3. Sintering was effected at 900 °C for 5 hours.

The resulting heat-treated thin film showed a T_c of 110 K.

Claims

1. A process for preparing superconductor of bismuth-containing compound-oxide, characterized by the steps comprising preparing an intermediate compound oxide composed of metal elements which are constituent elements of said superconductor except bismuth and of oxygen, and subjecting said intermediate compound oxide to heat-treatment at a temperature between 750 and 950 °C in an atmosphere containing bismuth oxide vapour so that bismuth oxide reacts with said intermediate compound oxide to produce the superconductor.
2. The process set forth in claim 1 wherein said bismuth oxide vapour is created by heating bismuth oxide powder in a chamber.
3. The process set forth in claim 1 or 2 wherein said superconductor is in a form of a thin film deposited on a substrate.



Substrate temperature	760 °C
Sputtering gas pressure	1.33 - 13.3 Pa (0.01 to 0.1 Torr)
Sputtering gas	Ar/O ₂ = 1 : 1
RF-frequency power	100 W
Thickness of the film	0.2 µm

Preparation of the superconductor

The resulting thin film as the intermediate compound oxide was subjected to heat-treatment with bismuth oxide vapour according to the present invention as follows :

The MgO substrate 3 having the thin film of Sr-Ca-Cu compound oxide was secured to the holder 4 as is shown in FIG. 1. The boat 5 which was faced to the substrate 3 was filled with bismuth oxide powder.

The furnace 1 was evacuated through the outlet port 8. After the valve 10 was closed, oxygen gas was introduced into the furnace 1 and then the valve 9 was closed so that the interior of the furnace is filled with oxygen gas. Then, the heater 2 was energized to heat the interior of the furnace to 880 °C, while the heater 6 was energized to heat the boat 5 up to 1,040 °C. When the boat 5 was heated at 1,040 °C, this temperature was maintained for one hour and then the heaters were de-energized.

After the furnace was cooled down to room temperature, the MgO substrate was taken out of the furnace to measure the critical temperature. Namely, the MgO substrate was dipped in liquid helium in a cryostat at 8 K in order to confirm that the thin film deposited on the substrate was changed to a superconductor, the temperature was elevated gradually to determine a critical temperature (T_c) where the thin film showed ordinal resistance.

It was confirmed that the critical temperature (T_c) of the thin film obtained was 97 K.

Example 2

Example 1 was repeated but, in this Example, the intermediate compound oxide was exposed to bismuth oxide vapour directly.

Namely, the sintered block of the intermediate compound oxide which was prepared by the same method as is described in "preparation of the intermediate compound oxide " of Example 1 was supported by the holder 4 and was heat-treated with bismuth oxide vapour.

The resulting heat-treated block showed a T_c of 105 K.

Example 3

Example 1 was repeated except that the intermediate compound oxide of Sr-Ca-Cu was replaced by an intermediate compound oxide of Pb-Sr-Ca-Cu. In this Example, Pb was added in a form of lead oxide and the atomic ratios in the material powder were adjusted to Pb : Sr : Ca : Cu = 0.3 : 2 : 2 : 3. Sintering was effected at 900 °C for 5 hours.

The resulting heat-treated thin film showed a T_c of 110 K.

Claims

1. A process for preparing superconductor of bismuth-containing compound-oxide, characterized by the steps comprising preparing an intermediate compound oxide composed of metal elements which are constituent elements of said superconductor except bismuth and of oxygen, and subjecting said intermediate compound oxide to heat-treatment at a temperature between 750 and 950 °C in an atmosphere containing bismuth oxide vapour so that bismuth oxide reacts with said intermediate compound oxide to produce the superconductor.
2. The process set forth in claim 1 wherein said bismuth oxide vapour is created by heating bismuth oxide powder in a chamber.
3. The process set forth in claim 1 or 2 wherein said superconductor is in a form of a thin film deposited on a substrate.



4. The process set forth in any one of Claims 1 to 3 wherein said intermediate compound oxide has a form of a thin film prepared on the substrate by physical vapour deposition technique.
5. The process set forth in Claim 3 or 4 wherein the substrate is a single crystal of MgO , SrTiO_3 , LaAlO_3 or LaGaO_3 .
6. The process set forth in Claim 5 wherein the film is deposited on $\{100\}$ plane or $\{110\}$ of the substrate.
7. The process set forth in Claim 4 wherein said physical vapour deposition technique is sputtering.
8. The process set forth in Claim 7 wherein a target used in the sputtering is a sintered block or sintered powder of a compound oxide containing metal elements which are constituent elements of said intermediate compound oxide.
9. The process set forth in Claim 8 wherein said sintered block or sintered powder is prepared by mixing powders of oxides, carbonates, nitrates or fluorides each containing at least one of constituent metal elements of said intermediate compound oxide in such a manner that the resulting powder mixture contains the constituent metal elements except bismuth in predetermined atomic ratios and then by sintering the powder mixture.
10. The process set forth in Claim 3 wherein said thin film is prepared by heating the substrate at a temperature lower than 800°C during the sputtering.
11. The process set forth in any one of Claims 1 to 10 wherein the superconducting thin film is made of a compound oxide of Bi, Sr, Ca and Cu.
12. The process set forth in Claim 11 wherein the compound oxide consists mainly of compound oxides represented by the general formula:

$$\text{Bi}_4(\text{Sr}_{1-x}\text{Ca}_x)_m\text{Cu}_n\text{O}_{p+y}$$

in which "m", "n", "x" and "y" are numbers each satisfying respective ranges of $6 \leq m \leq 16$, $4 \leq n \leq 12$, $0.2 < x < 0.8$ and $-2 \leq y \leq +2$ and $p = 6 + m + n$.

36 Patentansprüche

1. Verfahren zur Herstellung eines Supraleiters aus einer Wismut enthaltenden Oxydverbindung, gekennzeichnet durch die Schritte umfassend die Herstellung einer Zwischenoxydverbindung bestehend aus Metallelementen, die Bestandteile des Supraleiters sind, ausgenommen Wismut, und aus Sauerstoff und die Unterwerfung der Zwischenoxydschicht einer Wärmebehandlung bei einer Temperatur zwischen 750 und 950°C in einer Atmosphäre, die Wismutoxyddampf enthält, so daß das Wismutoxyd mit der Zwischenoxydverbindung zur Ausbildung des Supraleiters reagiert.
2. Verfahren nach Anspruch 1, bei dem der Wismutoxyddampf erzeugt wird durch Erwärmen von Wismutoxydpulver in einer Kammer.
3. Verfahren nach Anspruch 1 oder 2, bei dem der Supraleiter in Form eines dünnen Films auf einem Substrat abgeschieden wird.
4. Verfahren nach einem der Ansprüche 1, 3, bei dem die Zwischenoxydverbindung die Form eines dünnen Films aufweist, der durch die physikalische Dampfabscheidetechnik auf einem Substrat erzeugt wird.
5. Verfahren nach Anspruch 3 oder 4, bei dem das Substrat ein Einkristall aus MgO , SrTiO_3 , LaAlO_3 oder LaGaO_3 ist.
6. Verfahren nach Anspruch 5, bei dem der dünne Film auf der (100)-Ebene oder der (110)-Ebene des Substrats abgeschieden wird.



7. Verfahren nach Anspruch 4, bei dem die physikalische Dampfabcheidetechnik eine Kathodenzerstäubung ist.
8. Verfahren nach Anspruch 7, bei dem das bei der Kathodenzerstäubung verwendete Target ein gesinterter Block oder ein gesinteres Pulver einer Metallelemente enthaltenden Oxydverbindung ist, wobei letztere die Bestandteile der Zwischenoxydverbindung sind.
9. Verfahren nach Anspruch 8, bei dem der gesinterte Block oder das gesinterte Pulver hergestellt wird durch Mischen von Pulvern von Oxyden, Karbonaten, Nitraten oder Fluoriden, deren jedes wenigstens ein Metallelement enthält, das Bestandteil der Zwischenoxydverbindung ist, dergestalt, daß das erhaltene Pulvergemisch die die Bestandteile bildenden Metallelemente, ausgenommen Wismut, in vorgegebenen Atomverhältnissen enthält, wonach das Pulvergemisch gesintert wird.
10. Verfahren nach Anspruch 3, bei dem der dünne Film erzeugt wird durch Erwärmen des Substrats auf eine Temperatur von weniger als 800 ° C während der Kathodenzerstäubung.
11. Verfahren nach einem der Ansprüche 1 bis 10, bei dem der supraleitende dünne Film aus einer Oxydverbindung aus Bi, Sr, Ca und Cu hergestellt wird,
12. Verfahren nach Anspruch 11, bei dem die Oxydverbindung hauptsächlich aus Oxydverbindungen der allgemeinen Formel besteht:



wobei m, n, x und y Zahlen sind, die die folgenden entsprechenden Ungleichungen erfüllen: $6 \leq m \leq 16$, $4 \leq n \leq 12$, $0,2 < x < 0,8$ und $-2 \leq y \leq +2$ und $p = 6 + m + n$.

Revendications

1. Procédé de préparation d'un supraconducteur d'oxyde composé contenant du bismuth, caractérisé par les opérations consistant à préparer un oxyde composé intermédiaire formé, d'une part, d'éléments métalliques qui sont des éléments constitutants du supraconducteur à l'exception du bismuth et, d'autre part, d'oxygène, et à soumettre l'oxyde composé intermédiaire à un traitement thermique à une température comprise entre 750 et 950 ° C dans une atmosphère contenant de la vapeur d'oxyde de bismuth, de façon telle que l'oxyde de bismuth réagisse avec l'oxyde composé intermédiaire de manière à produire le supraconducteur.
2. Procédé suivant la revendication 1, selon lequel la vapeur d'oxyde de bismuth est créée en chauffant de la poudre d'oxyde de bismuth dans une chambre.
3. Procédé suivant l'une des revendications 1 ou 2, selon lequel le supraconducteur se présente sous la forme d'un film mince déposé sur un substrat.
4. Procédé suivant l'une quelconque des revendications 1 à 3, selon lequel l'oxyde composé intermédiaire se présente sous la forme d'un film mince préparé sur le substrat par une technique de dépôt en phase gazeuse par procédé physique.
5. Procédé suivant l'une des revendications 3 ou 4, selon lequel le substrat est un cristal unique de MgO , SrTiO_3 , LaAlO_3 ou LaGaO_3 .
6. Procédé suivant la revendication 5, selon lequel le film mince est déposé sur un plan {100} ou un plan {110} du substrat.
7. Procédé suivant la revendication 4, selon lequel la technique de dépôt en phase gazeuse par procédé physique est une pulvérisation cathodique.
8. Procédé suivant la revendication 7, selon lequel la cible utilisée dans la pulvérisation cathodique est un bloc fritté ou une poudre frittée d'oxyde composé contenant des éléments métalliques qui sont des



éléments constituant de l'oxyde composé intermédiaire.

9. Procédé suivant la revendication 8, selon lequel le bloc fritté ou la poudre frittée est préparé en mélangeant des poudres d'oxydes, de carbonates, de nitrates ou de fluorures contenant chacun au moins l'un des éléments métalliques constituant de l'oxyde composé intermédiaire, d'une manière telle que le mélange de poudres résultant contienne les éléments métalliques constituant, à l'exception du bismuth, dans des rapports atomiques préfixés, puis en frittant le mélange de poudres.
10. Procédé suivant la revendication 3, selon lequel le film mince est préparé en chauffant le substrat à une température inférieure à 800 °C pendant la pulvérisation cathodique.
11. Procédé suivant l'une quelconque des revendications 1 à 10, selon lequel le film mince supraconducteur est formé d'un oxyde composé de Bi, Sr, Ca et Cu.
12. Procédé suivant la revendication 11, selon lequel l'oxyde composé est constitué principalement d'oxydes composés représentés par la formule générale :



dans laquelle m, n, x et y sont des nombres satisfaisant chacun les conditions respectives : $6 \leq m \leq 16,4$, $0,2 < x < 0,8$ et $-2 \leq y \leq +2$ et $p = 6 + m + n$.